# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

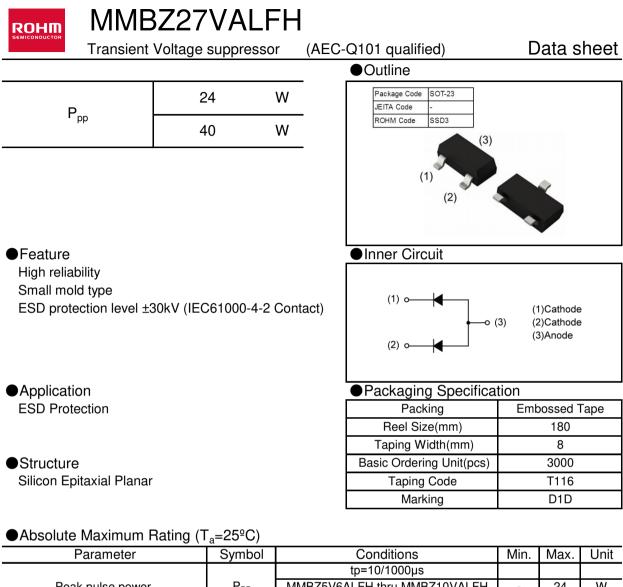
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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1 diditiotoi	Cymbol	Conditione			max.	
		tp=10/1000µs				
Peak pulse power	P <sub>PP</sub>	MMBZ5V6ALFH thru MMBZ10VALFH		-	24	W
		MMBZ12VALFH thru M	-	40	W	
	$V_{ESD}$	IEC61000-4-2	Air discharge	-	±30	kV
Electrostatic discharge voltage*			Contact	-	±30	kV
Electrostatic discharge voltage		Machine model		-	±2	V
		Human body model		-	±8	kV
Junction temperature	Тj	-		-	150	°C
Storage temperature	T <sub>stg</sub>	-			150	°C
Power dissipation	P <sub>d</sub>	on Glass-epoxy substrate		-	225	mW
Power dissipation		on Alumina substrate		-	300	mW
		* IEC61000-4-2 C	=150pF R=330	Ω	_	

## Data sheet

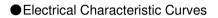
MMBZ27VALFH • Electrical Characteristic (T<sub>a</sub> = 25°C)

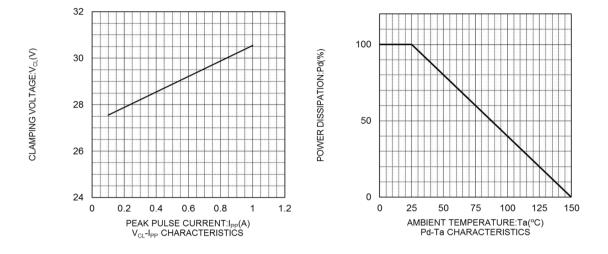
	Symbol										
P/N	V <sub>RWM</sub> (V)	4 V <sub>BR</sub> (V)		Ι <sub>R</sub> (μΑ)		V <sub>F</sub> (V) I <sub>F</sub> =10mA	V <sub>CL</sub> (V)		C <sub>t</sub> (pF) V <sub>R</sub> =0V f=1MHz		
	MAX.	MIN.	Nom.	MAX.	I <sub>t</sub> (mA)	MAX.	$V_{R}(V)$	MAX.	MAX.	$I_{pp}(A)$	Nom.
MMBZ5V6ALFH	3.0	5.32	5.60	5.88	20	5	3.0	0.9	8.0	3.00	230
MMBZ6V2ALFH	3.0	5.89	6.20	6.51	1	0.2	3.0	0.9	8.7	2.76	180
MMBZ6V8ALFH	4.5	6.46	6.80	7.14	1	0.3	4.5	0.9	9.6	2.50	165
MMBZ9V1ALFH	6.0	8.65	9.10	9.56	1	0.1	6.0	0.9	14.0	1.70	120
MMBZ10VALFH	6.5	9.50	10.00	10.50	1	0.05	6.5	0.9	14.2	1.70	105
MMBZ12VALFH	8.5	11.40	12.00	12.60	1	0.05	8.5	0.9	17.0	2.35	85
MMBZ15VALFH	12.0	14.25	15.00	15.75	1	0.05	12.0	0.9	21.0	1.90	75
MMBZ16VALFH	13.0	15.20	16.00	16.80	1	0.05	13.0	0.9	23.0	1.70	70
MMBZ18VALFH	14.5	17.10	18.00	18.90	1	0.05	14.5	0.9	25.0	1.60	60
MMBZ20VALFH	17.0	19.00	20.00	21.00	1	0.05	17.0	0.9	28.0	1.40	55
MMBZ24VALFH	20.0	22.80	24.00	25.20	1	0.05	20.0	0.9	32.0	1.25	46
MMBZ27VALFH	22.0	25.65	27.00	28.35	1	0.05	22.0	0.9	40.0	1.00	42
MMBZ30VALFH	24.0	28.50	30.00	31.50	1	0.05	24.0	0.9	43.0	0.95	38
MMBZ33VALFH	26.0	31.35	33.00	34.65	1	0.05	26.0	0.9	46.0	0.87	34

### Marking

P/N	Marking	P/N	Marking
MMBZ5V6ALFH	D0M	MMBZ16VALFH	D0Y
MMBZ6V2ALFH	D0N	MMBZ18VALFH	D0Z
MMBZ6V8ALFH	D0P	MMBZ20VALFH	D1A
MMBZ9V1ALFH	D0S	MMBZ24VALFH	D1C
MMBZ10VALFH	D0T	MMBZ27VALFH	D1D
MMBZ12VALFH	D0V	MMBZ30VALFH	D1E
MMBZ15VALFH	D0X	MMBZ33VALFH	D1F

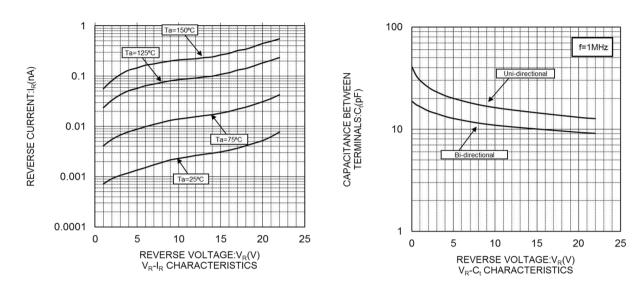








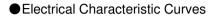
# MMBZ27VALFH

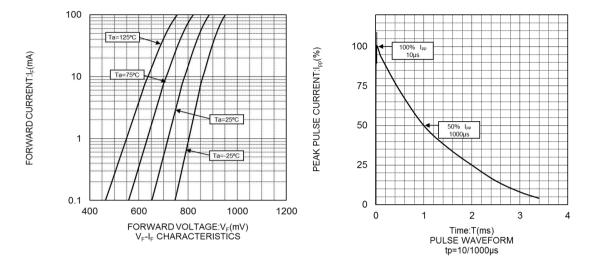


#### • Electrical Characteristic Curves



2016/5/31\_Rev.001



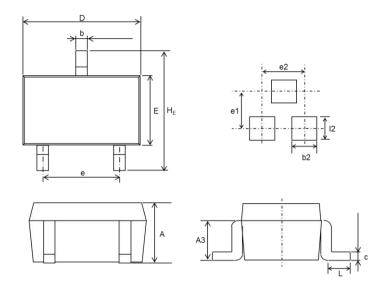




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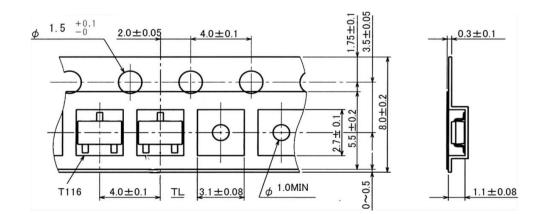
## MMBZ27VALFH

### Dimension (SOT-23 SSD3)



DIM		Milimeters		Inches		
DIN	Min.	Average	Max.	Min.	Average	Max.
A	0.85	0.95	1.15	0.033	0.037	0.045
A3	0.35	0.45	0.55	0.014	0.018	0.022
b	0.35	0.40	0.50	0.014	0.016	0.020
С	0.09	0.15	0.25	0.004	0.006	0.010
D	2.70	2.90	3.10	0.106	0.114	0.122
E	1.20	1.30	1.50	0.047	0.051	0.059
Η <sub>E</sub>	2.20	2.40	2.60	0.086	0.094	0.102
L	0.20	-	-	0.008	-	-
е	1.70	1.90	2.10	0.067	0.075	0.083
12	1.00	-	-	0.039	-	-
b2	0.80	-	-	0.031	-	-
e1	-	2.40	-	-	0.094	-
e2	-	1.90	-	-	0.075	-

●Taping



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# Notice

#### **Precaution on using ROHM Products**

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

JAPAN	USA	EU	CHINA	
CLASSII	CLASSI	CLASS II b	CLASSⅢ	
CLASSⅣ	CLASSII	CLASSⅢ	CLASSII	

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

[a] Installation of protection circuits or other protective devices to improve system safety

[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

#### Precaution for Foreign Exchange and Foreign Trade act

Since concerned goods might be fallen under listed items of export control prescribed by Foreign exchange and Foreign trade act, please consult with ROHM in case of export.

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- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.